

Support information for

Epitaxial Growth of Large-scale In₂S₃ Nanoflakes and the Construction of High Performance In₂S₃/Si Photodetector

Jianting Lu¹, Zhaoqiang Zheng^{1, 2*}, Wei Gao¹, Jiandong Yao³, Yu Zhao¹, Ye Xiao¹, Bing Wang⁴

Jingbo Li^{1, 5*}

¹ School of Materials and Energy, Guangdong University of Technology, Guangzhou, 510006, Guangdong, P. R. China.

² Department of Electronic Engineering, The Chinese University of Hong Kong, Hong Kong SAR, P. R. China.

³ State Key Laboratory of Optoelectronic Materials and Technologies, Nanotechnology Research Center, School of Materials Science & Engineering, Sun Yat-sen University, Guangzhou, 510275, Guangdong, P. R. China.

⁴ Institute of Micro-nano Optoelectronic Technology, Shenzhen Key Lab of Micro-nano Photonic Information Technology, College of Electronic Science and Technology, Shenzhen University, Shenzhen, 518060, Guangdong, P. R. China.

⁵ State Key Laboratory for Superlattices and Microstructures, Institute of Semiconductors, Chinese Academy of Sciences, Beijing, 100083, P. R. China.

*Corresponding authors: zhengzhq5@mail2.sysu.edu.cn and jbli@semi.ac.cn

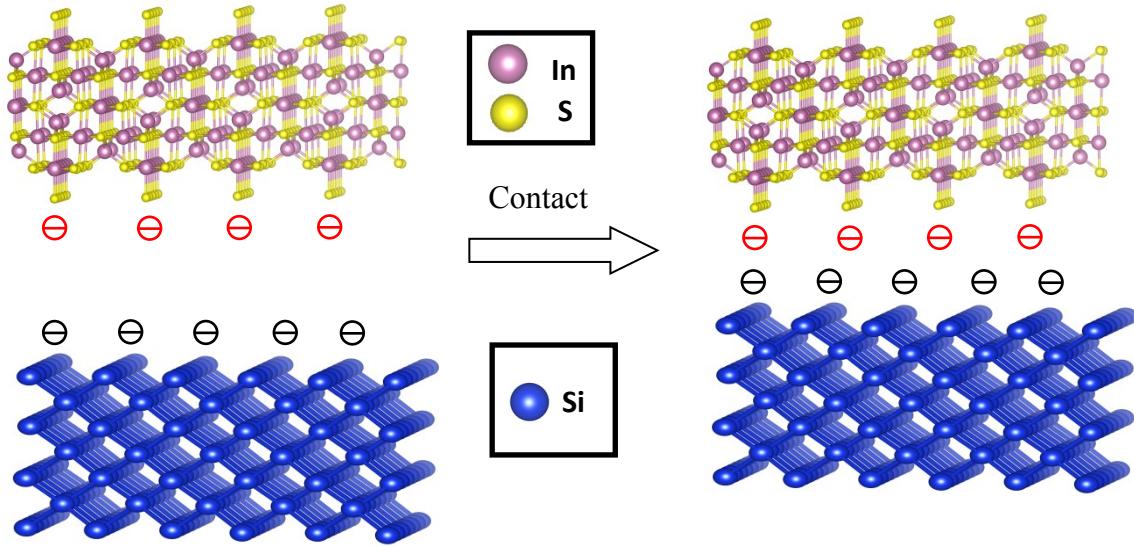


Figure S1. Compatibility between In_2S_3 and Si. Since both In_2S_3 and Si are non-layered structures, there are many unsaturated dangling bonds on the surface of S atoms and Si atoms, as shown on the left. After the transfer of In_2S_3 onto Si, since the electronegativity of the S atom is greater than that of the Si atom, the unsaturated dangling bonds on the surface Si atoms will be attracted to the surface of the S atoms, as shown on the right. Therefore, In_2S_3 and Si will be tightly packed together to form an excellent heterojunction.

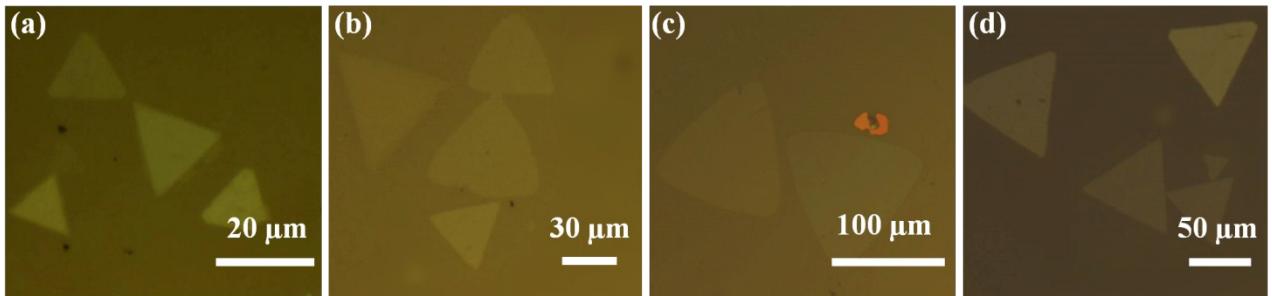


Figure S2. Optical images of the as-grown β - In_2S_3 flakes obtained at different temperatures: (a) 900 °C. (b) 950 °C. (c) 980 °C. (d) 1020 °C. As can be seen, we have prepared In_2S_3 nanoflakes under various temperatures. With the increase of the growth temperature, the size of the In_2S_3 nanoflakes increases. When the growth temperature increases to be more than 980 °C, the size slightly declines. Therefore, 980 °C is chosen as the optimum growth temperature in this work.

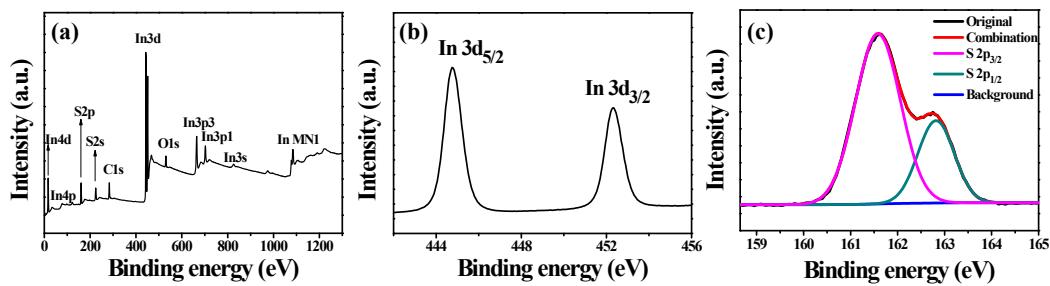


Figure S3. XPS pattern of In_2S_3 . (a) Full spectrum of In_2S_3 . Core spectrum of (b) $\text{In}_{3\text{d}}$ and (c) $\text{S}_{2\text{p}}$.

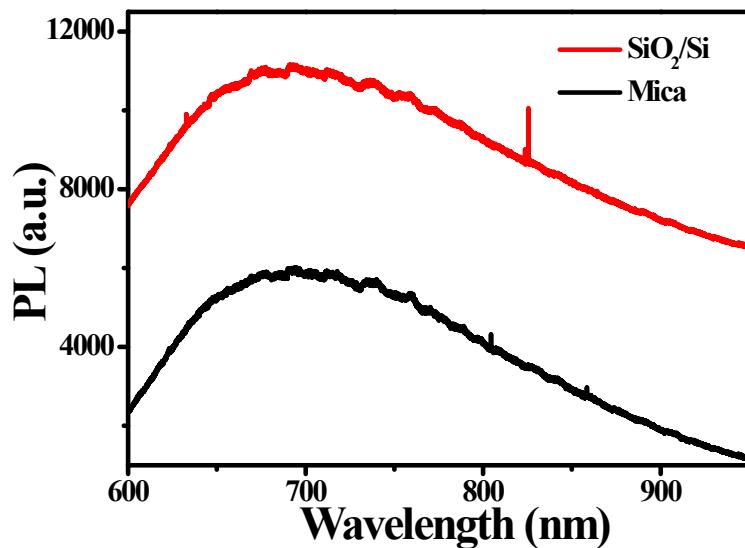


Figure S4. PL spectrum of original In_2S_3 on the mica substrate (before) and transferred In_2S_3 on SiO_2/Si substrate (after).

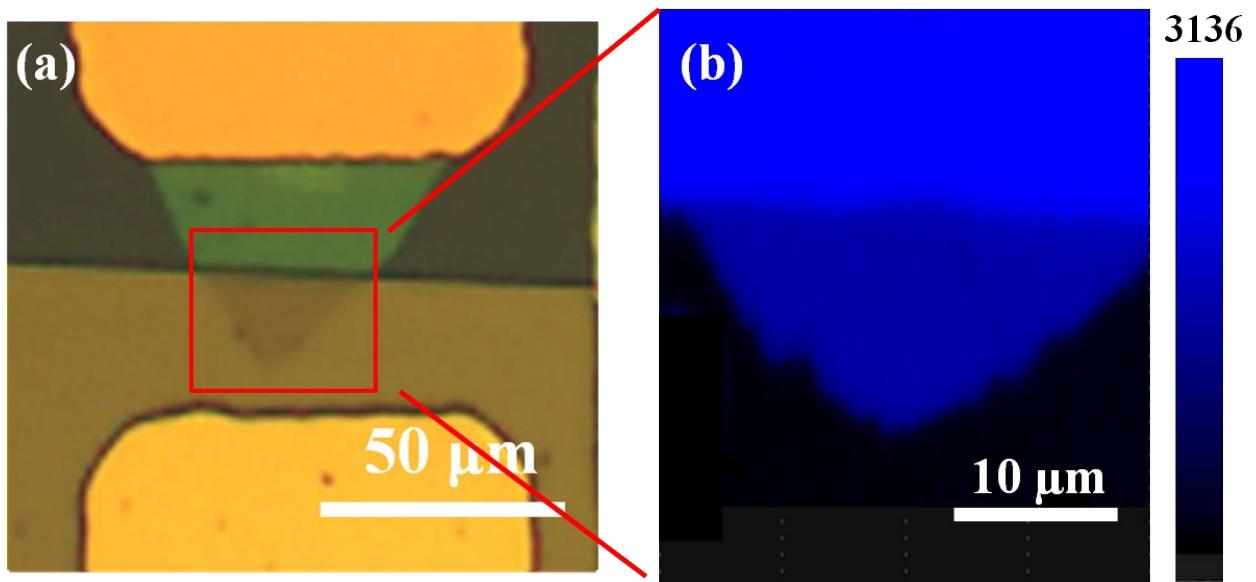


Figure S5. (a) Optical microscope image of the $\text{In}_2\text{S}_3/\text{Si}$ device. (b) The PL mapping of the $\text{In}_2\text{S}_3/\text{Si}$ device, corresponding to the red rectangle in (a). Recognizable PL quenching is observed at the $\text{In}_2\text{S}_3/\text{Si}$ heterojunction.

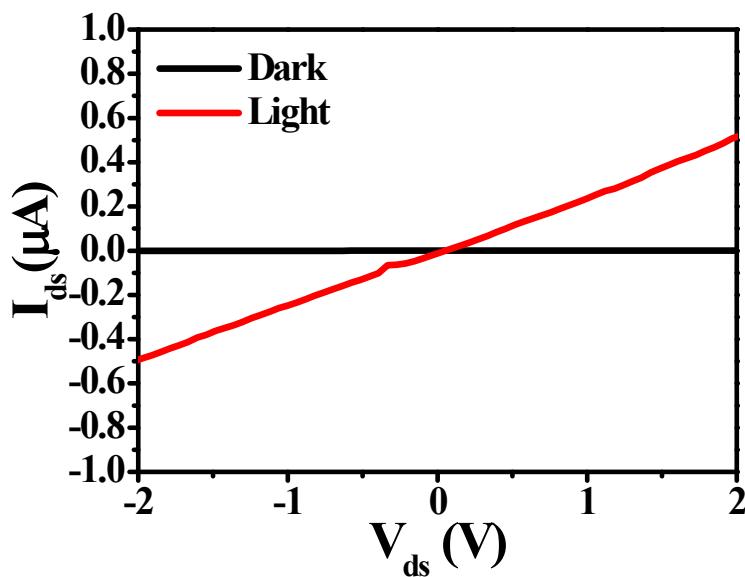


Figure S6. I_{ds} - V_{ds} curves of planar In_2S_3 device under dark and light illumination. The nearly linear I-V curves prove the good Ohmic-contacts for $\text{Ti}/\text{Au}-\text{In}_2\text{S}_3$.

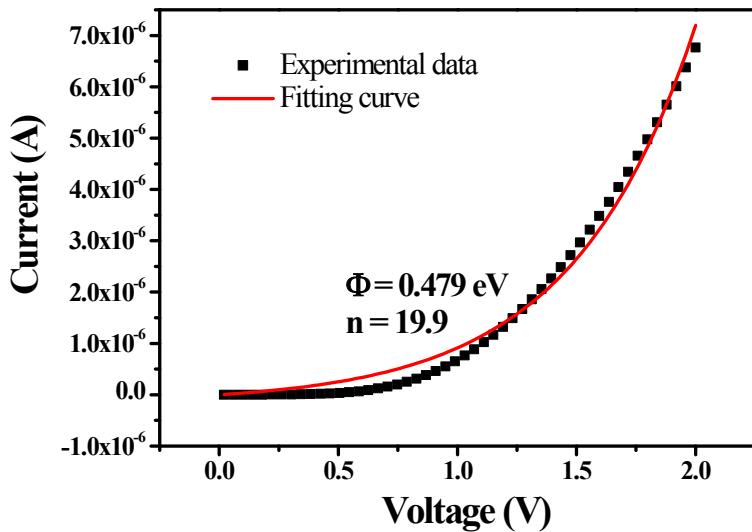


Figure S7. The fitting curve of barrier height of the $\text{In}_2\text{S}_3/\text{Si}$ heterojunction by using the thermionic emission theory-based diode equation.

The current through a Schottky junction can be described by the well-known Richardson–Dushman thermionic emission theory¹⁻²:

$$I = I_s \left[\exp \left(\frac{eV}{nkT} \right) - 1 \right] \quad (1)$$

$$I_s = A_1 A^* T^2 \exp \left(-\frac{e\phi_b}{kT} \right) \quad (2)$$

where I_s is the reverse saturation current, e is the electronic charge, V is the bias voltage, n is the ideality factor, k is the Boltzmann constant, T is the absolute temperature, A_1 is the area of the device, ϕ_b is the Schottky barrier height, and A^* is the effective Richardson constant ($32 \text{ A cm}^{-2} \text{ K}^{-2}$ for p-type Si). On the basis of the above equations, by fitting the dark I–V curves of these two devices, ϕ_b can be deduced to be 0.479 eV for the graphene/Si Schottky junction.

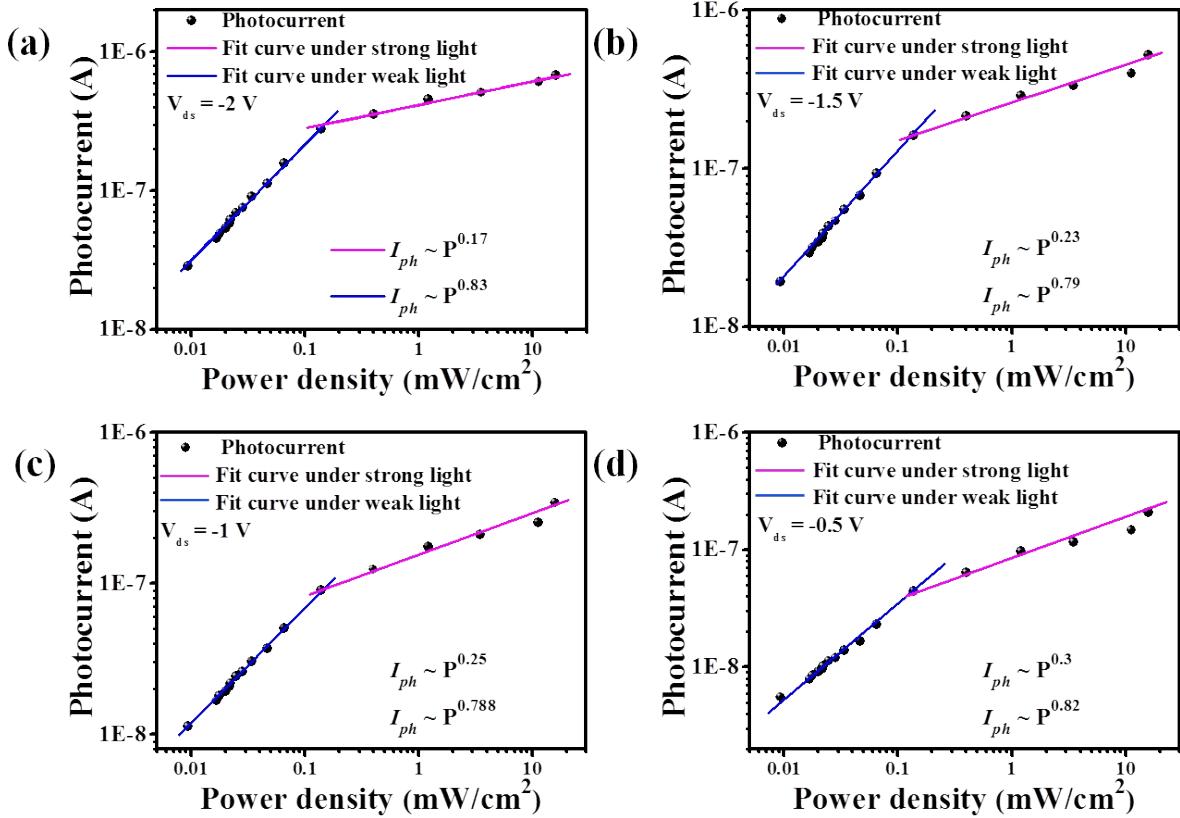


Figure S8. Photocurrent versus illumination power density at the applied voltage of (a) -2 V; (b) -1.5 V (c) -1 V (d) -0.5 V.

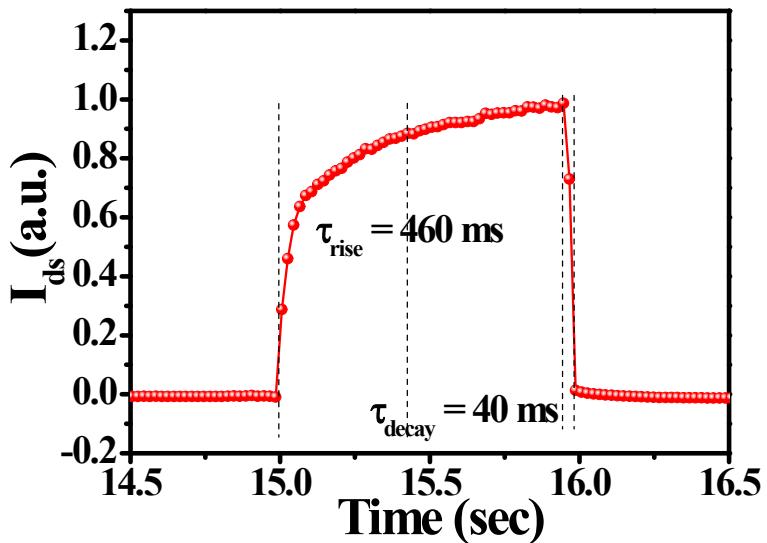


Figure S9. The magnified and normalized plot of one response cycle of pure In_2S_3 device.

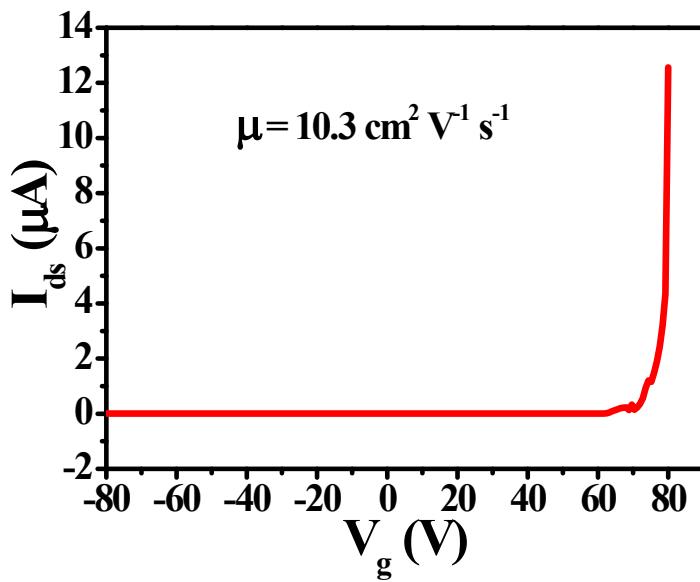


Figure S10. The transfer curve of planar In_2S_3 device.

The electron mobility can be acquired by the following equation³⁻⁴

$$\mu = \frac{\partial I_{ds}}{\partial V_g} \left(\frac{Ld}{W\epsilon_0\epsilon_r V_{ds}} \right)$$

$$\frac{\partial I_{ds}}{\partial V_g}$$

where L and W are the length and width of the channel, $\frac{\partial I_{ds}}{\partial V_g}$ is slope of the transfer curve, μ is mobility, ϵ_r is the relative static permittivity, ϵ_0 is the electric constant, and d is the thickness of the SiO_2 layer. Herein, $V_{ds} = 2 \text{ V}$, $L = 14 \text{ } \mu\text{m}$, $W = 22 \text{ } \mu\text{m}$, and $d = 300 \text{ nm}$. Then, $\epsilon_0 = 8.85 \times 10^{-12} \text{ F/m}$,

$\epsilon_r = 3.9$, and $\frac{\partial I_{ds}}{\partial V_g} = 4.58 \times 10^{-7} \text{ A/V}$. Based on the data above, the electron mobility is calculated to be $10.3 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$.

Table S1. Key parameters comparison between our $\text{In}_2\text{S}_3/\text{Si}$ device and other non-layered 2D materials based photodetectors. Commercial Si device is also included.

Devices	Method	Lateral (μm)	R (A/W)	D* (Jones)	On/off ratio	Rise/decay time (ms)	Ref.
$\text{In}_2\text{S}_3/\text{Si}$	PVE	~ 161	579.6	2.1×10^{11}	~ 552	9/0.131	Ours
In_2S_3	CVD	~ 10	137	7.74×10^{10}	ND	6/8	⁵
In_2S_3	HT	~ 5	ND	ND	16	2000/100	⁶
CdTe	CVD	5-11	0.6×10^{-3}	10^9	27	18.4/14.7	⁷
SnTe	PVD	~ 30	71	ND	~ 2	210/730	⁸
PbS	HT	~ 1	0.472	ND	100	ND	⁹
PbS	CVD	2-2.6	1621	10^{11}	~ 2	300/300	¹⁰
$\text{Pb}_{1-x}\text{Sn}_x\text{Se}$	CVD	~ 15	5.95	ND	~ 3	900/740	¹¹
Te	CVD	6-10	160	ND	~ 3	4400/2800	¹²
Commercial	ND	ND	0.5	3×10^{12}	ND	ND	¹³
Si							

Ref.: reference. CVD: chemical vapor deposition. PVE: physical vapor epitaxy. ME: mechanical exfoliation. HT: Hydrothermal. ND: no data. Gr: graphene.

Reference

1. Wang, L.; Jie, J. S.; Shao, Z. B.; Zhang, Q.; Zhang, X. H.; Wang, Y. M.; Sun, Z.; Lee, S. T., MoS₂/Si Heterojunction with Vertically Standing Layered Structure for Ultrafast, High-Detectivity, Self-Driven Visible-Near Infrared Photodetectors. *Adv. Funct. Mater.* **2015**, *25* (19), 2910-2919.
2. Zheng, Z. Q.; Zhu, L. F.; Wang, B., In₂O₃ Nanotower Hydrogen Gas Sensors Based on Both Schottky Junction and Thermoelectronic Emission. *Nanoscale Res. Lett.* **2015**, *10*, 293.
3. Li, B.; Huang, L.; Zhong, M. Z.; Li, Y.; Wang, Y.; Li, J. B.; Wei, Z. M., Direct Vapor Phase Growth and Optoelectronic Application of Large Band Offset SnS₂/MoS₂ Vertical Bilayer Heterostructures with High Lattice Mismatch. *Adv. Electron. Mater.* **2016**, *2* (11), 1600298.
4. Li, Y. T.; Wang, Y.; Huang, L.; Wang, X. T.; Li, X. Y.; Deng, H. X.; Wei, Z. M.; Li, J. B., Anti-Ambipolar Field-Effect Transistors Based On Few-Layer 2D Transition Metal Dichalcogenides. *ACS Appl. Mater. Interfaces* **2016**, *8* (24), 15574-15581.
5. Huang, W.; Gan, L.; Yang, H.; Zhou, N.; Wang, R.; Wu, W.; Li, H.; Ma, Y.; Zeng, H.; Zhai, T., Controlled Synthesis of Ultrathin 2D β-In₂S₃ with Broadband Photoresponse by Chemical Vapor Deposition. *Adv. Funct. Mater.* **2017**, 1702448.
6. Acharya, S.; Dutta, M.; Sarkar, S.; Basak, D.; Chakraborty, S.; Pradhan, N., Synthesis of Micrometer Length Indium Sulfide Nanosheets and Study of Their Dopant Induced Photoresponse Properties. *Chem. Mater.* **2012**, *24* (10), 1779-1785.
7. Cheng, R.; Wen, Y.; Yin, L.; Wang, F.; Wang, F.; Liu, K.; Shifa, T. A.; Li, J.; Jiang, C.; Wang, Z.; He, J., Ultrathin Single-Crystalline CdTe Nanosheets Realized via Van der Waals Epitaxy. *Adv. Mater.* **2017**, *29* (35), 1703122.
8. Yang, J.; Yu, W.; Pan, Z.; Yu, Q.; Yin, Q.; Guo, L.; Zhao, Y.; Sun, T.; Bao, Q.; Zhang, K., Ultra-Broadband Flexible Photodetector Based on Topological Crystalline Insulator SnTe with High Responsivity. *Small* **2018**, e1802598.
9. Schliehe, C.; Juarez, B. H.; Pelletier, M.; Jander, S.; Greshnykh, D.; Nagel, M.; Meyer, A.; Foerster, S.; Kornowski, A.; Klinke, C., Ultrathin PbS Sheets by Two-dimensional Oriented Attachment. *Science* **2010**, *329* (5991), 550-553.
10. Wen, Y.; Wang, Q.; Yin, L.; Liu, Q.; Wang, F.; Wang, F.; Wang, Z.; Liu, K.; Xu, K.; Huang, Y.; Shifa, T. A.; Jiang, C.; Xiong, J.; He, J., Epitaxial 2D PbS Nanoplates Arrays with Highly Efficient Infrared Response. *Adv. Mater.* **2016**, *28* (36), 8051-8057.
11. Wang, Q.; Xu, K.; Wang, Z.; Wang, F.; Huang, Y.; Safdar, M.; Zhan, X.; Wang, F.; Cheng, Z.; He, J., Van Der Waals Epitaxial Ultrathin Two-dimensional Nonlayered Semiconductor for Highly Efficient Flexible Optoelectronic Devices. *Nano Lett.* **2015**, *15* (2), 1183-1189.
12. Wang, Q.; Safdar, M.; Xu, K.; Mirza, M.; Wang, Z.; He, J., Van der Waals Epitaxy and Photoresponse of Hexagonal Tellurium Nanoplates on Flexible Mica Sheets. *ACS Nano* **2014**, *8* (7), 7497-7505.
13. Saran, R.; Curry, R. J., Lead Sulphide Nanocrystal Photodetector Technologies. *Nat. Photonics* **2016**, *10* (2), 81-92.